

High-performance Clock Generator Series

DVD-Audio Reference Clock Generator for Audio/Video Appliance

BU2285FV, BU2363FV



● Description

These clock generators are an IC generating three types of clocks - VIDEO, AUDIO and SYSTEM clocks – necessary for DVD player systems, with a single chip through making use of the PLL technology. Particularly, the VIDEO clock is a DVD-Audio reference and yet achieves high C/N characteristics necessary to provide high definition images.

● Features

- 1) Connecting a crystal oscillator generates multiple clock signals with a built-in PLL.
- 2) The AUDIO clock provides switching selection outputs
- 3) The VIDEO clock achieves high C/N characteristics.
- 4) Single power supply of 3.3 V

● Applications

DVD players

● Lineup

Part name		BU2285FV	BU2363FV	
Supply voltage [V]		3.0 ~ 3.6	3.0 ~ 3.6	
Reference frequency [MHz]		36.8640	36.8640	
Output frequency [MHz]	DVD VIDEO	2	54.0000	
		1	27.0000	
		1/2	13.5000	
	DVD / CD AUDIO (Switching outputs)	768fs	36.8640 / 33.8688	
		512fs	—	
		384fs	18.4320 / 16.9344	
		256fs	—	
		768fs	33.8688	
	SYSTEM	384fs	16.9344	
Jitter 1 σ [psec]		50	50	
C/N [dB] (VIDEO)		-60	-80	
Package		SSOP-B24	SSOP-B16	

Sep. 2008

● Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	BU2285FV	BU2363FV	Unit
Supply voltage	VDD	-0.5 ~ +7.0	-0.5 ~ +7.0	V
Input voltage	VIN	-0.5 ~ VDD+0.5	-0.5 ~ VDD+0.5	V
Storage temperature range	T _{stg}	-30 ~ +125	-30 ~ +125	°C
Power dissipation	PD	630 ^{*1}	450 ^{*2}	mW

*1 In the case of exceeding at Ta = 25°C, 6.3mW should be reduced per 1°C

*2 In the case of exceeding at Ta = 25°C, 4.5mW should be reduced per 1°C

* Operating is not guaranteed.

* The radiation-resistance design is not carried out.

* Power dissipation is measured when the IC is mounted to the printed circuit board.

● Recommended Operating Range

Parameter	Symbol	BU2285FV	BU2363FV	Unit
Supply voltage	VDD	3.0 ~ 3.6	3.0 ~ 3.6	V
Input H voltage	VIH	0.8VDD ~ VDD	0.8VDD ~ VDD	V
Input L voltage	VIL	0.0 ~ 0.2VDD	0.0 ~ 0.2VDD	V
Operating temperature	T _{opr}	-5 ~ +70	-10 ~ +70	°C
Maximum output load	CL	15	15	pF

● Electrical characteristics

◎BU2285FV (VDD=3.3V, Ta=25°C, Crystal frequency 36.8640MHz, unless otherwise specified.)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Output L voltage	VOL	—	—	0.4	V	IOL=4.0mA
Output H voltage	VOH	2.4	—	—	V	IOH=-4.0mA
Consumption current	IDD	—	30	50	mA	At no load
CLK54M	CLK54M	—	54.0000	—	MHz	XTAL × 375 / 128 / 2
CLK27M	CLK27M	—	27.0000	—	MHz	XTAL × 375 / 128 / 4
CLKDAC	CLKDAC_H	—	27.0000	—	MHz	At CTRLB=OPEN, XTAL × 375 / 128 / 4
	CLKDAC_L	—	13.5000	—	MHz	At CTRLB=L, XTAL × 375 / 128 / 8
CLK33M	CLK33M	—	33.8688	—	MHz	XTAL × 147 / 40 / 4
CLK16M	CLK16M	—	16.9344	—	MHz	XTAL × 147 / 40 / 8
CLKA	CLKA_H	—	36.8640	—	MHz	At CTRLA=OPEN, XTAL output
	CLKA_L	—	33.8688	—	MHz	At CTRLA=L, XTAL × 147 / 40 / 4
CLKB	CLKB_H	—	18.4320	—	MHz	At CTRLA=OPEN, XTAL / 2 output
	CLKB_L	—	16.9344	—	MHz	At CTRLA=L, XTAL × 147 / 40 / 8
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2VDD
Period-Jitter 1σ	P-J 1σ	—	50	—	psec	*1
Period-Jitter MIN-MAX	P-J MIN-MAX	—	300	—	psec	*2
Rise Time	Tr	—	2.5	—	nsec	Period of transition time required for the clock output to reach 80% from 20% of VDD
Fall Time	Tf	—	2.5	—	nsec	Period of transition time required for the clock output to reach 20% from 80% of VDD
Output Lock-Time	Tlock	—	—	1	msec	*3

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to XTALIN.

If the input frequency is set to 36.8640MHz, the output frequency will be as listed above.

◎BU2363FV (VDD=3.3V, Ta=25°C, Crystal frequency 36.8640MHz, unless otherwise specified.)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Output L voltage	VOL	—	—	0.4	V	IOL=4.0mA
Output H voltage	VOH	2.4	—	—	V	IOH=—4.0mA
Consumption current	IDD	—	30	50	mA	At no load
CLK54M	CLK54M	—	54.0000	—	MHz	XTAL×375 / 64 / 4
CLK27M	CLK27M	—	27.0000	—	MHz	XTAL×375 / 64 / 8
CLK33M	CLK33M	—	33.8688	—	MHz	XTAL×147 / 40 / 4
CLK16M	CLK16M	—	16.9344	—	MHz	XTAL×147 / 40 / 8
CLK768FS1	CLK768_H	—	36.8640	—	MHz	At FSEL=OPEN, XTAL output
	CLK768_L	—	33.8688	—	MHz	At FSEL=L, XTAL×147 / 40 / 4
CLK384FS2	CLK384_H	—	18.4320	—	MHz	At FSEL=OPEN, XTAL / 2 output
	CLK384_L	—	16.9344	—	MHz	At FSEL=L, XTAL×147 / 40 / 8
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2VDD
Period-Jitter 1 σ	P-J 1 σ	—	50	—	psec	*1
Period-Jitter MIN-MAX	P-J MIN-MAX	—	300	—	psec	*2
Rise Time	Tr	—	2.5	—	nsec	Period of transition time required for the clock output to reach 80% from 20% of VDD
Fall Time	Tf	—	2.5	—	nsec	Period of transition time required for the clock output to reach 20% from 80% of VDD
Output Lock-Time	Tclock	—	—	1	msec	*3
C/N 54M	C/N 54M	-65	-80	—	dB	*4 (At a maximum load)
C/N 33M	C/N 33M	-50	-60	—	dB	*4 (At a maximum load)

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to XTALIN.

If the input frequency is set to 36.8640MHz, the output frequency will be as listed above.

Common to BU2285FV and BU2363FV:

*1 Period-Jitter 1 σ

This parameter represents standard deviation (=1 σ) on cycle distribution data at the time when the output clock cycles are sampled 1000 times consecutively with the TDS7104 Digital Phosphor Oscilloscope of Tektronix Japan, Ltd.

*2 Period-Jitter MIN-MAX

This parameter represents a maximum distribution width on cycle distribution data at the time when the output clock cycles are sampled 1000 times consecutively with the TDS7104 Digital Phosphor Oscilloscope of Tektronix Japan, Ltd.

*3 Output Lock-Time

The Lock-Time represents elapsed time after power supply turns ON to reach a 3.0V voltage, after the system is switched from Power-Down state to normal operation state, or after the output frequency is switched, until it is stabilized at a specified frequency, respectively.

BU2363FV

*4 Make measurements with settings of SPAN to 100kHz, RBW to 1kHz, and VBW to 100Hz taking the middle point between (54.0000MHz±20kHz) and (33.8688MHz±20kHz) as a measurement point.

● Reference data (BU2285FV basic data)

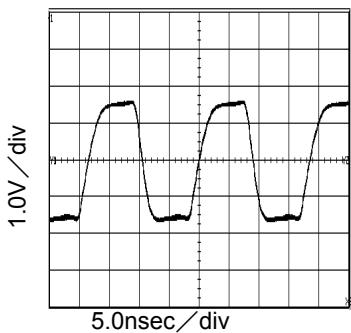


Fig.1 54MHz output waveform
VDD=3.3V, at CL=15pF

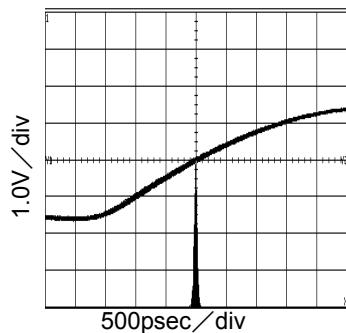


Fig.2 54MHz Period-Jitter
VDD=3.3V, at CL=15pF

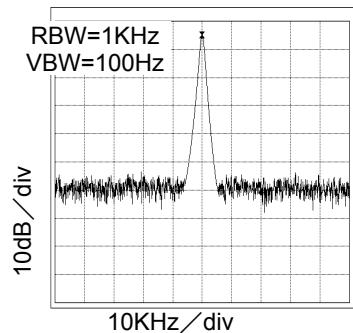


Fig.3 54MHz Spectrum
VDD=3.3V, at CL=15pF

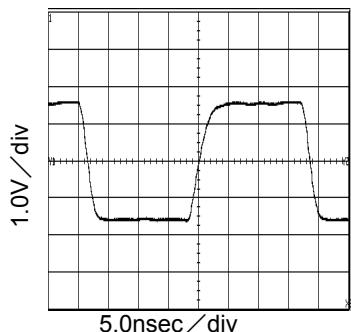


Fig.4 27MHz output waveform
VDD=3.3V, at CL=15pF

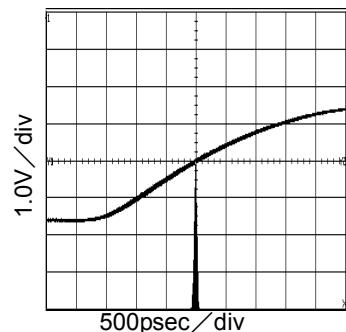


Fig.5 27MHz Period-Jitter
VDD=3.3V, at CL=15pF

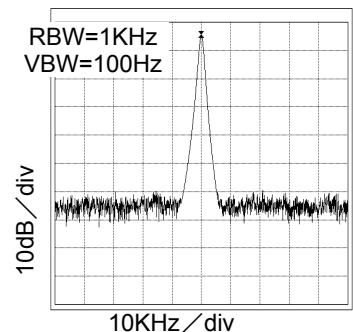


Fig.6 27MHz Spectrum
VDD=3.3V at CL=15pF

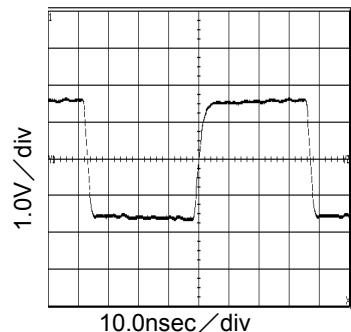


Fig.7 13.5MHz output waveform
VDD=3.3V, at CL=15pF

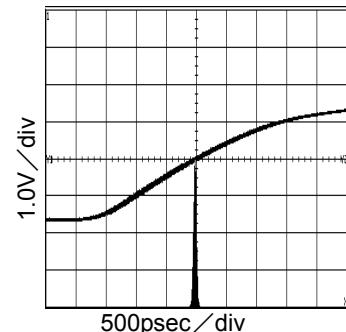


Fig.8 13.5MHz Period-Jitter
VDD=3.3V, at CL=15pF

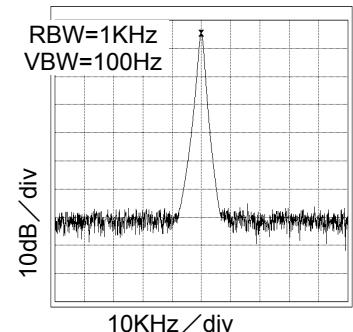


Fig.9 13.5MHz Spectrum
VDD=3.3V, at CL=15pF

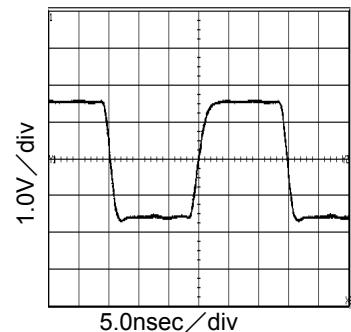


Fig.10 33.9MHz output waveform
VDD=3.3V, at CL=15pF

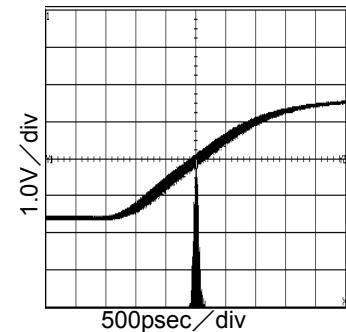


Fig.11 33.9MHz Period-Jitter
VDD=3.3V, at CL=15pF

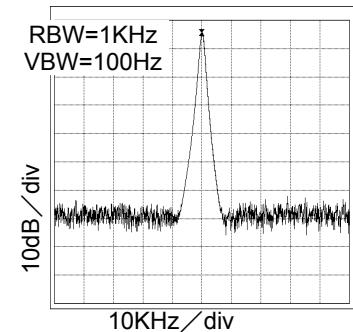


Fig.12 33.9MHz Spectrum
VDD=3.3V, at CL=15pF

●Reference data (BU2285FV basic data)

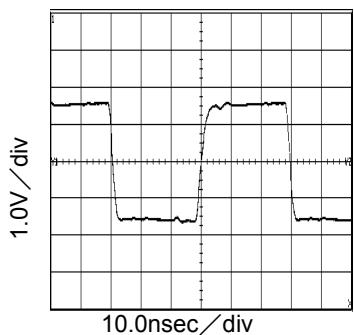


Fig.13 16.9MHz output waveform
VDD=3.3V, at CL=15pF

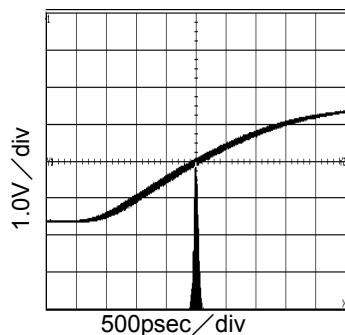


Fig.14 16.9MHz Period-Jitter
VDD=3.3V, at CL=15pF

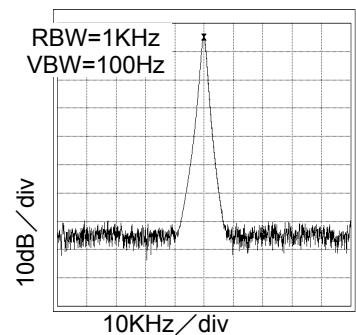


Fig.15 16.9MHz Spectrum
VDD=3.3V, at CL=15pF

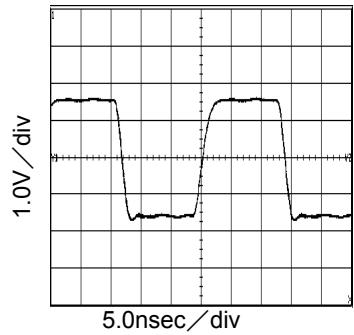


Fig.16 36.9MHz output waveform
VDD=3.3V, at CL=15pF

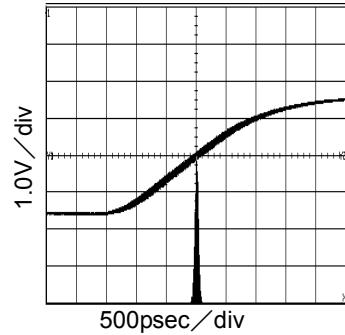


Fig.17 36.9MHz Period-Jitter
VDD=3.3V, at CL=15pF

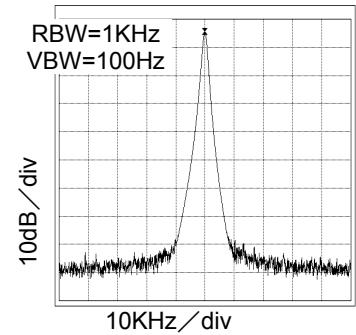


Fig.18 36.9MHz Spectrum
VDD=3.3V, at CL=15pF

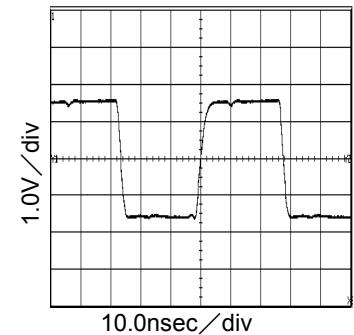


Fig.19 18.4MHz output waveform
VDD=3.3V, at CL=15pF

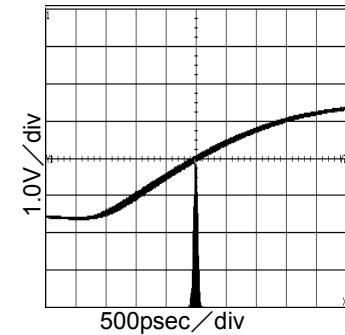


Fig.20 18.4MHz Period-Jitter
VDD=3.3V, at CL=15pF

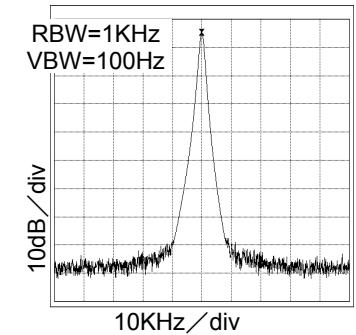


Fig.21 18.4MHz Spectrum
VDD=3.3V, at CL=15pF

● Reference data (BU2285FV Temperature and Supply voltage variations data)

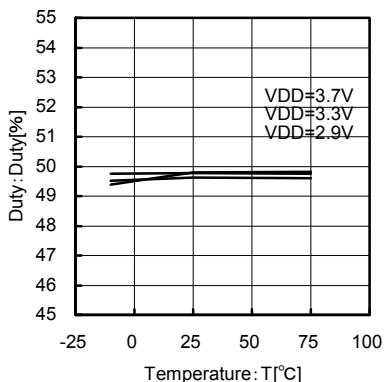


Fig.22 54MHz
Temperature – Duty

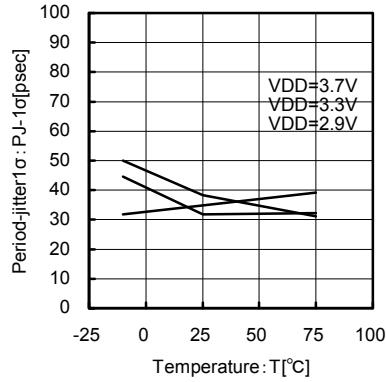


Fig.23 54MHz
Temperature – Period-Jitter 1σ

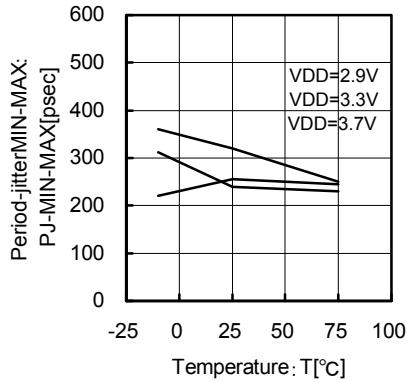


Fig.24 54MHz
Temperature – Period-Jitter MIN-MAX

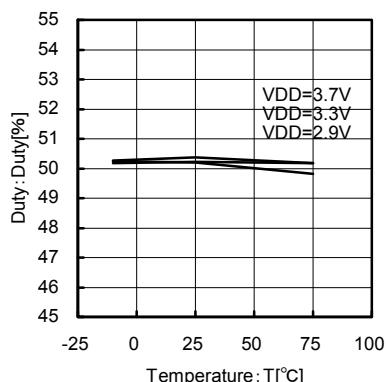


Fig.25 27MHz
Temperature – Duty

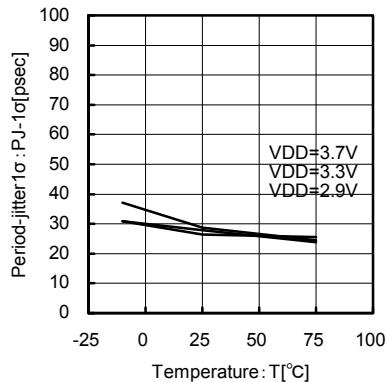


Fig.26 27MHz
Temperature – Period-Jitter 1σ

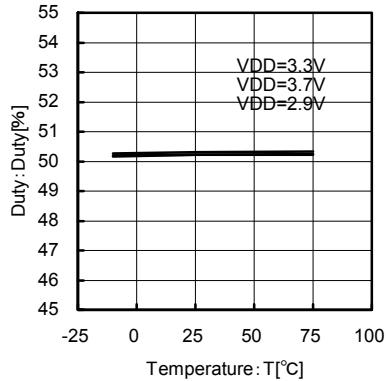


Fig.28 13.5MHz
Temperature – Duty

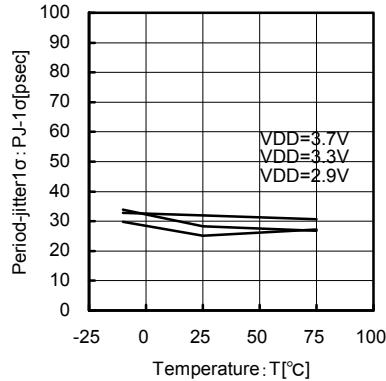


Fig.29 13.5MHz
Temperature – Period-Jitter 1σ

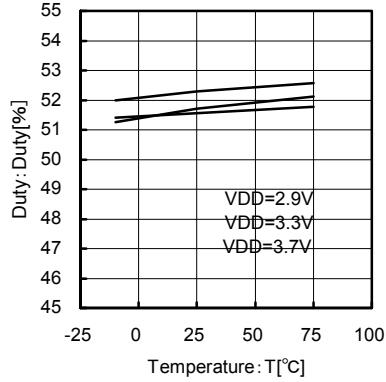


Fig.31 33.9MHz
Temperature – Duty

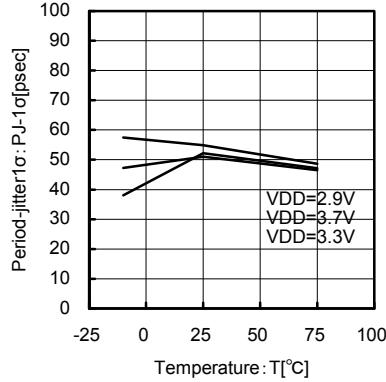


Fig.32 33.9MHz
Temperature – Period-Jitter 1σ

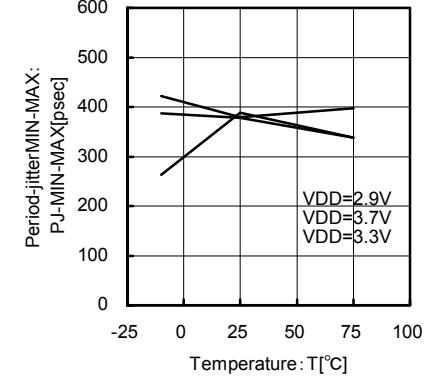


Fig.33 33.9MHz
Temperature – Period-Jitter MIN-MAX

● Reference data (BU2285FV Temperature and Supply voltage variations data)

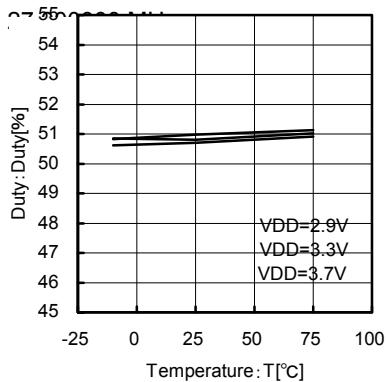


Fig.34 16.9MHz
Temperature – Duty

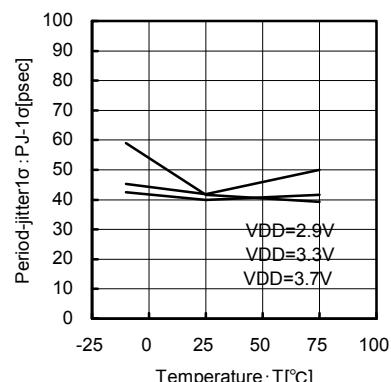


Fig.35 16.9MHz
Temperature – Period-Jitter 1 σ

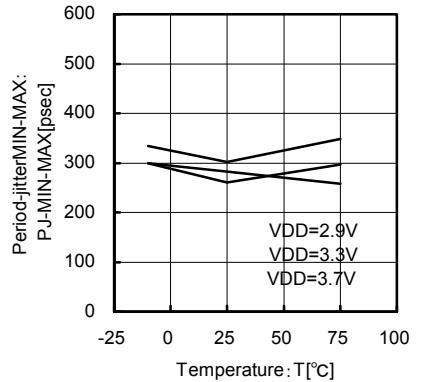


Fig.36 16.9MHz
Temperature – Period-Jitter MIN-MAX

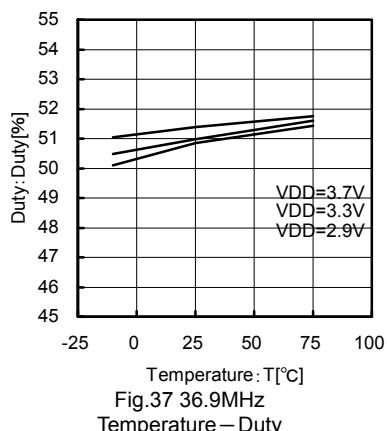


Fig.37 36.9MHz
Temperature – Duty

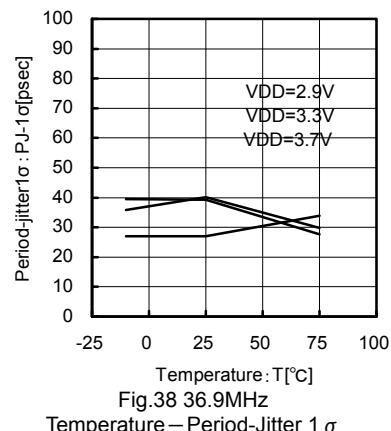


Fig.38 36.9MHz
Temperature – Period-Jitter 1 σ

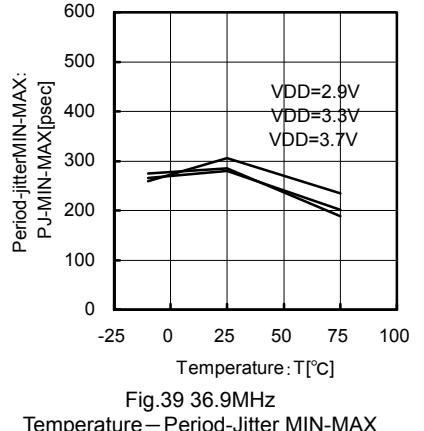


Fig.39 36.9MHz
Temperature – Period-Jitter MIN-MAX

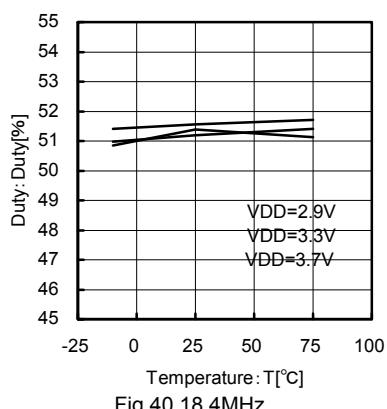


Fig.40 18.4MHz
Temperature – Duty

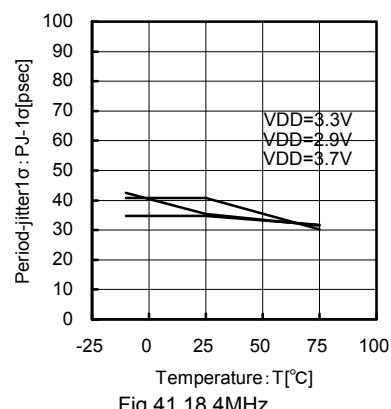


Fig.41 18.4MHz
Temperature – Period-Jitter 1 σ

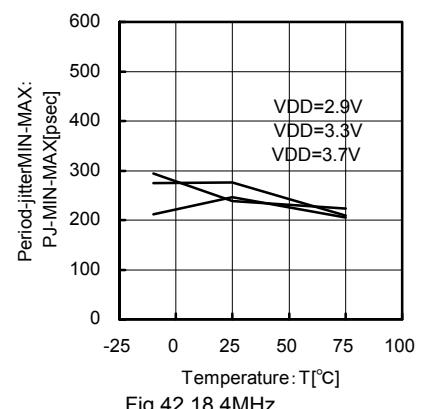


Fig.42 18.4MHz
Temperature – Period-Jitter MIN-MAX

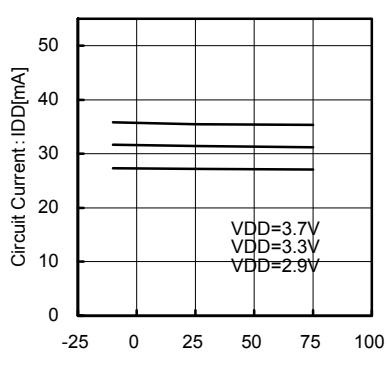


Fig.43 Consumption current (with maximum output load)
Temperature – Consumption current

● Reference data (BU2363FV basic data)

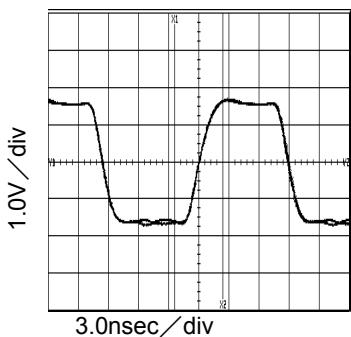


Fig.44 54MHz output waveform
VDD=3.3V, at CL=15pF

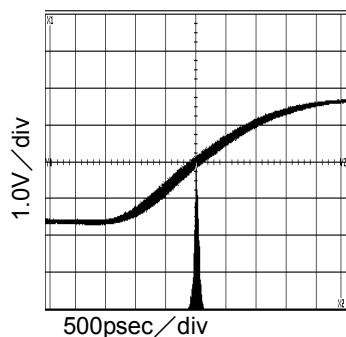


Fig.45 54MHz Period-Jitter
VDD=3.3V, at CL=15pF

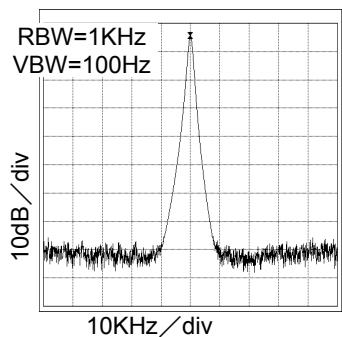


Fig.46 54MHz Spectrum
VDD=3.3V, at CL=15pF

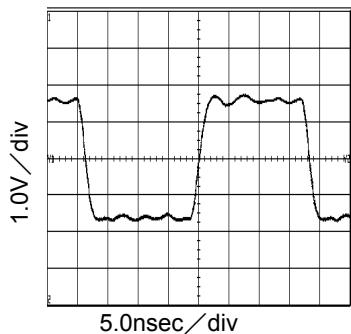


Fig.47 27MHz output waveform
VDD=3.3V, at CL=15pF

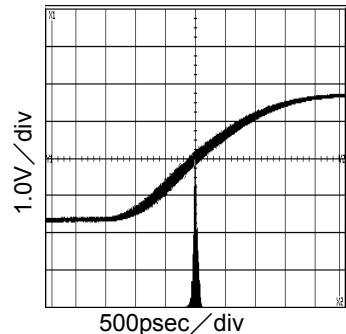


Fig.48 27MHz Period-Jitter
VDD=3.3V, at CL=15pF

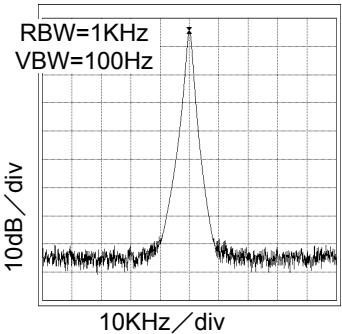


Fig.49 27MHz Spectrum
VDD=3.3V, at CL=15pF

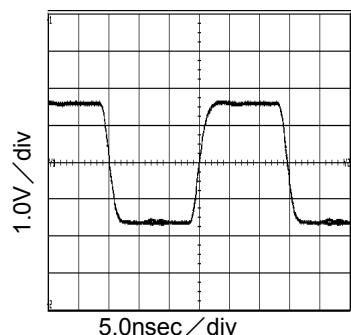


Fig.50 33.9MHz output waveform
VDD=3.3V, at CL=15pF

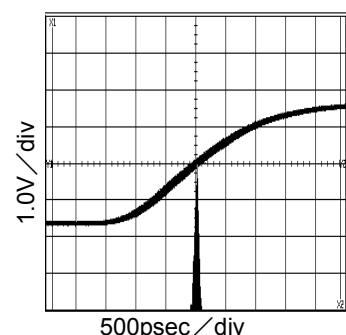


Fig.51 33.9MHz Period-Jitter
VDD=3.3V, at CL=15pF

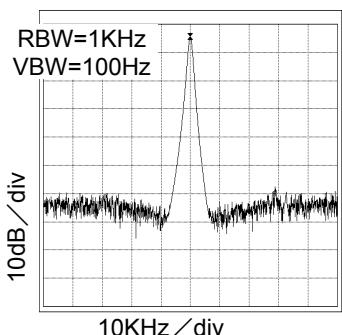


Fig.52 33.9MHz Spectrum
VDD=3.3V, at CL=15pF

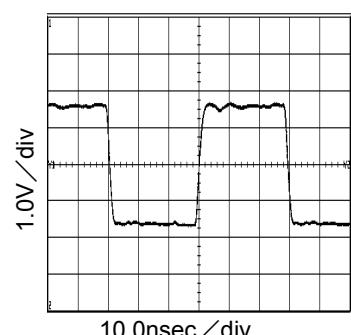


Fig.53 16.9MHz output waveform
VDD=3.3V, at CL=15pF

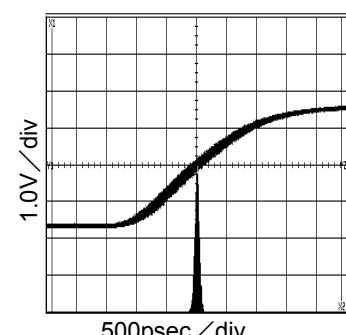


Fig.54 16.9MHz Period-Jitter
VDD=3.3V, at CL=15pF

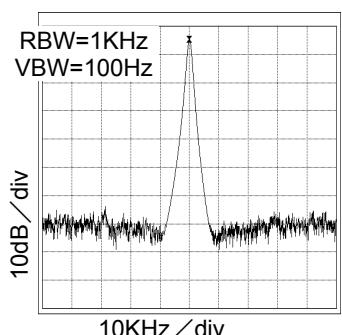


Fig.55 16.9MHz Spectrum
VDD=3.3V, at CL=15pF

● Reference data (BU2363FV basic data)

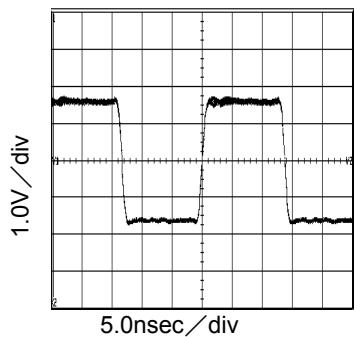


Fig.56 36.9MHz output waveform
VDD=3.3V, at CL=15pF

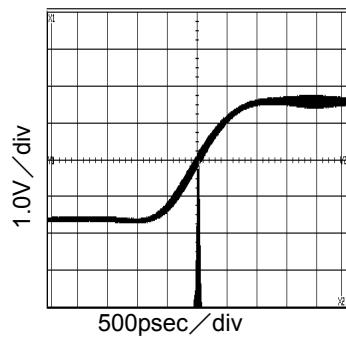


Fig.57 36.9MHz Period-Jitter
VDD=3.3V, at CL=15pF

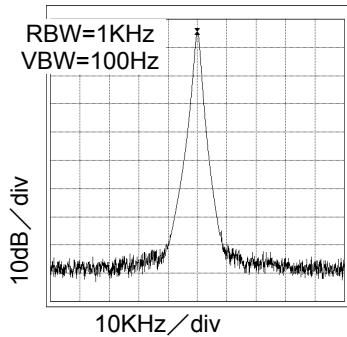


Fig.58 36.9MHz Spectrum
VDD=3.3V, at CL=15pF

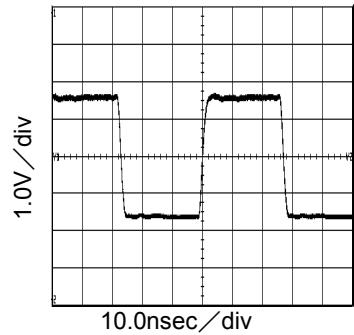


Fig.59 18.4MHz output waveform
VDD=3.3V, at CL=15pF

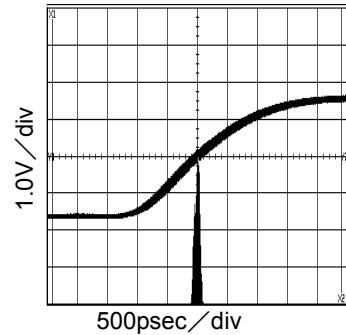


Fig.60 18.4MHz Period-Jitter
VDD=3.3V, at CL=15pF

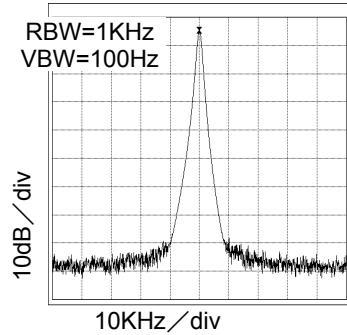


Fig.61 18.4MHz Spectrum
VDD=3.3V, at CL=15pF

● Reference data (BU2363FV Temperature and Supply voltage variations data)

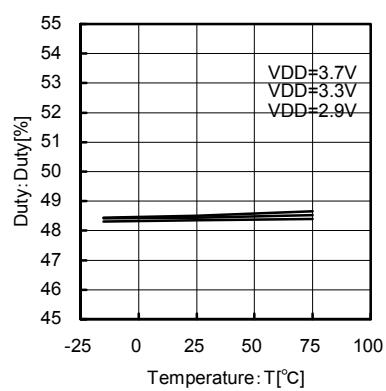


Fig.62 54MHz
Temperature – Duty

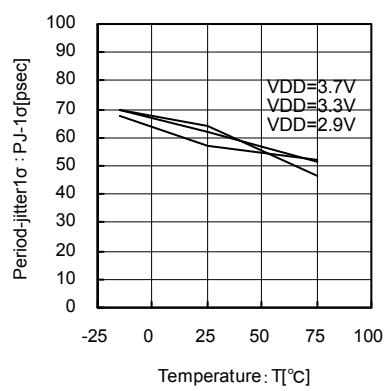


Fig.63 54MHz
Temperature – Period-Jitter 1 σ

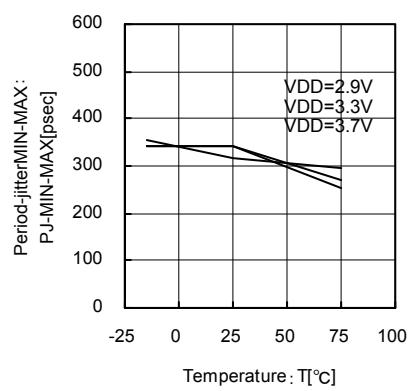


Fig.64 54MHz
Temperature – Period-Jitter MIN-MAX

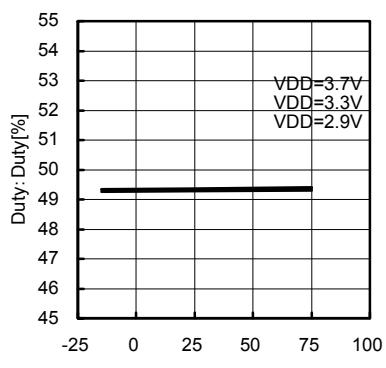


Fig.65 27MHz
Temperature – Duty

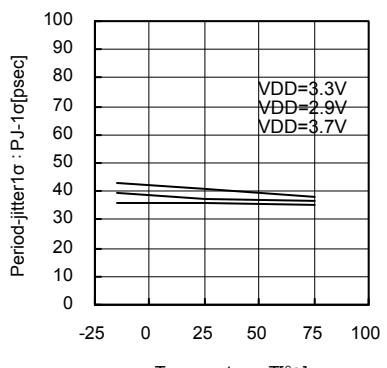


Fig.66 27MHz
Temperature – Period-Jitter 1 σ

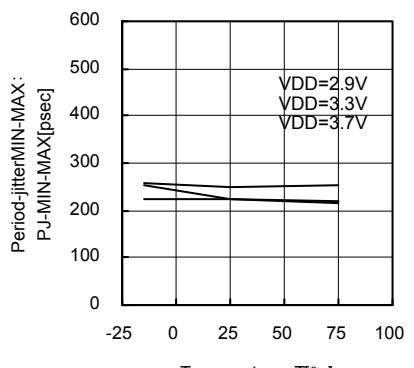


Fig.67 27MHz
Temperature – Period-Jitter MIN-MAX

● Reference data (BU2363FV Temperature and Supply voltage variations data)

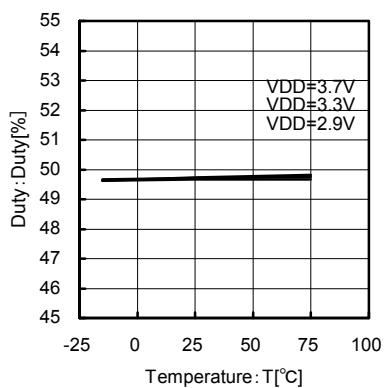


Fig.68 33.9MHz
Temperature – Duty

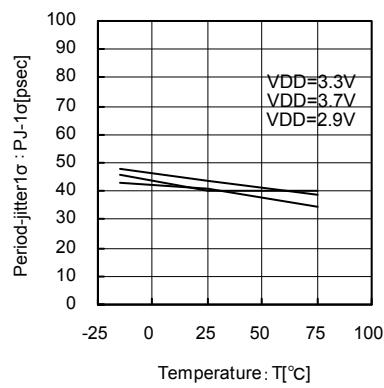


Fig.69 33.9MHz
Temperature – Period-Jitter 1 σ

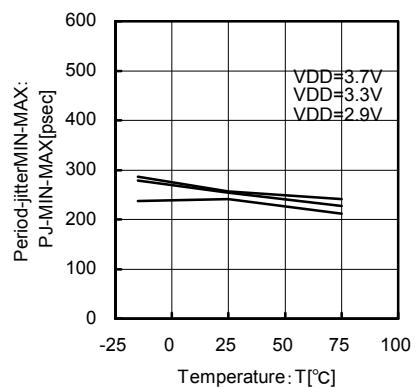


Fig.70 33.9MHz
Temperature – Period-Jitter MIN-MAX

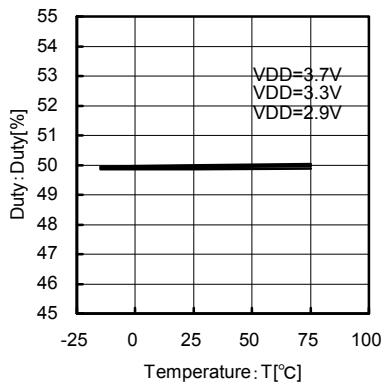


Fig.71 16.9MHz
Temperature – Duty

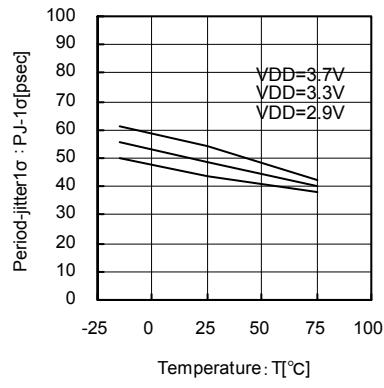


Fig.72 16.9MHz
Temperature – Period-Jitter 1 σ

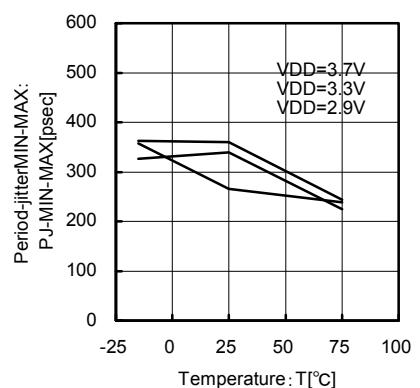


Fig.73 16.9MHz
Temperature – Period-Jitter MIN-MAX

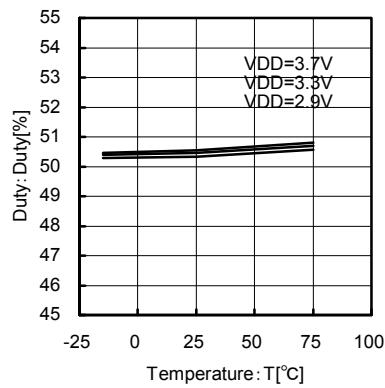


Fig.74 36.9MHz
Temperature – Duty

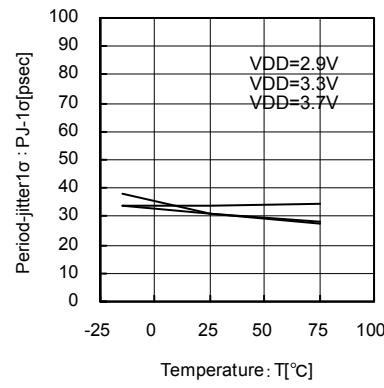


Fig.75 36.9MHz
Temperature – Period-Jitter 1 σ

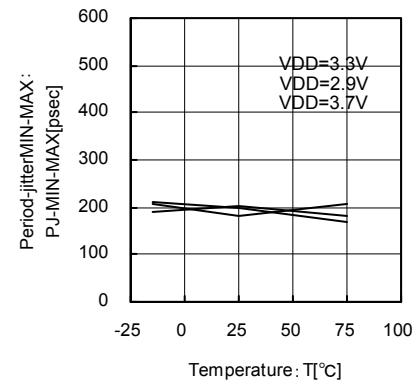


Fig.76 36.9MHz
Temperature – Period-Jitter MIN-MAX

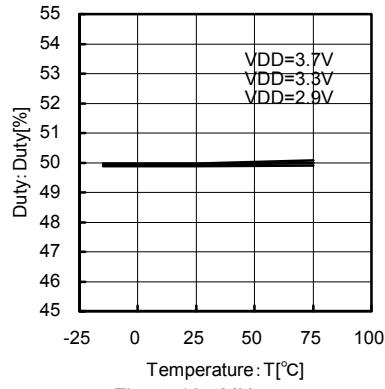


Fig.77 18.4MHz
Temperature – Duty

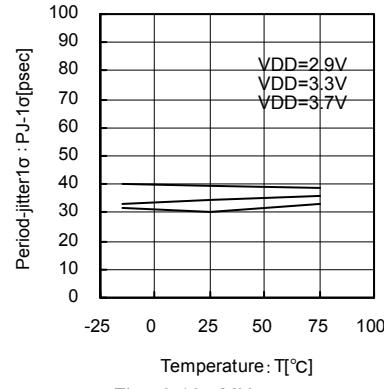


Fig.78 18.4MHz
Temperature – Period-Jitter 1 σ

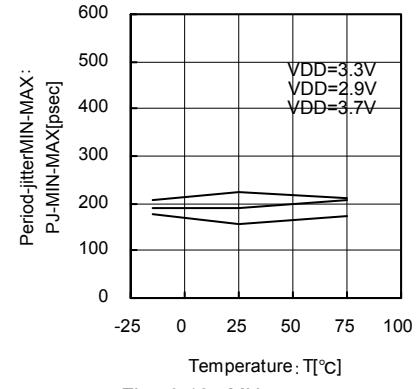


Fig.79 18.4MHz
Temperature – Period-Jitter MIN-MAX

● Reference data (BU2363FV Temperature and Supply voltage variations data)

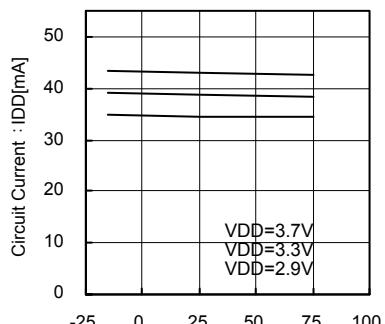


Fig.80 Consumption current
(with maximum output load)

Temperature – Consumption current

● Block diagram, Pin assignment

◎BU2285FV

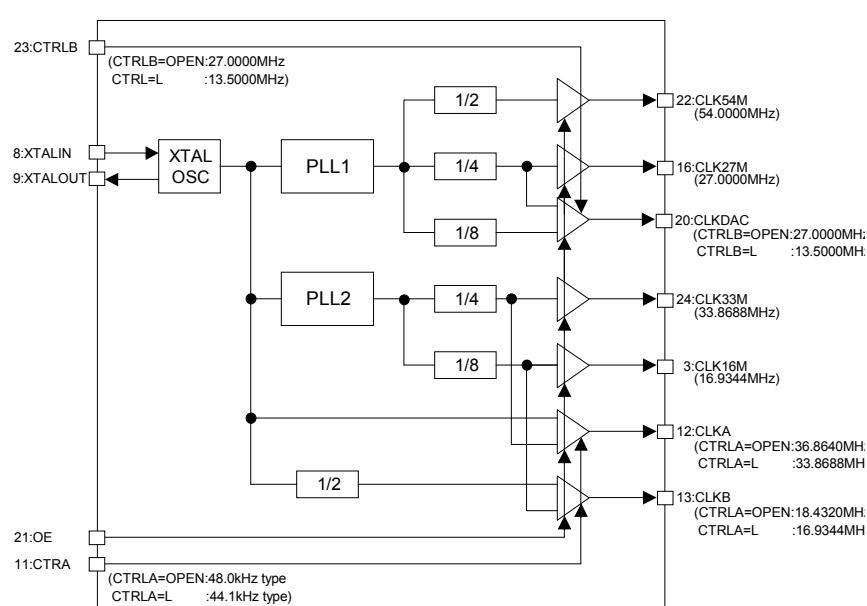
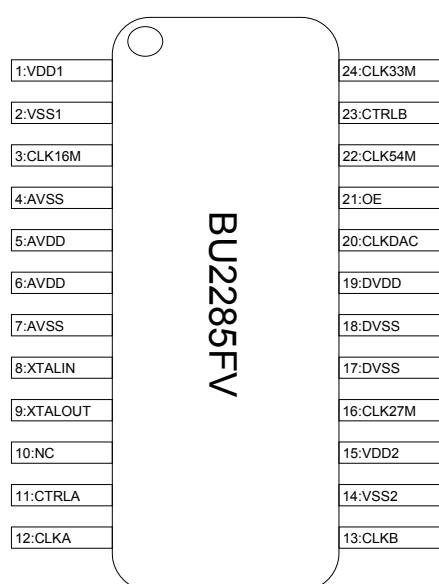


Fig.81



CTRLA	CLKA	CLKB
L	33.8688MHz	16.9344MHz
OPEN	36.8640MHz	18.4320MHz

CTRLB	CLKDAC
L	13.5000MHz
OPEN	27.0000MHz

Fig.82

● Block diagram, Pin assignment

◎BU2363FV

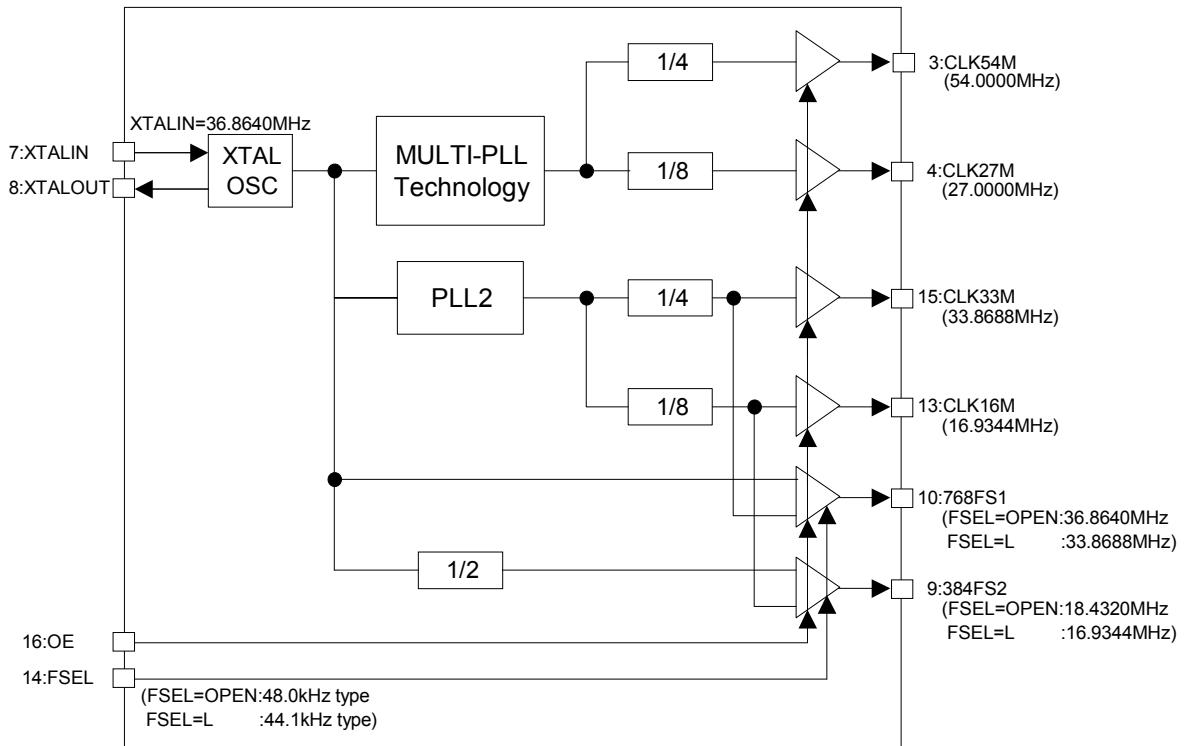


Fig.83



Fig.84

FSEL	CLK768FS	CLK384FS
L	33.8688MHz	16.9344MHz
OPEN	36.8640MHz	18.4320MHz

● Example of application circuit

◎BU2285FV

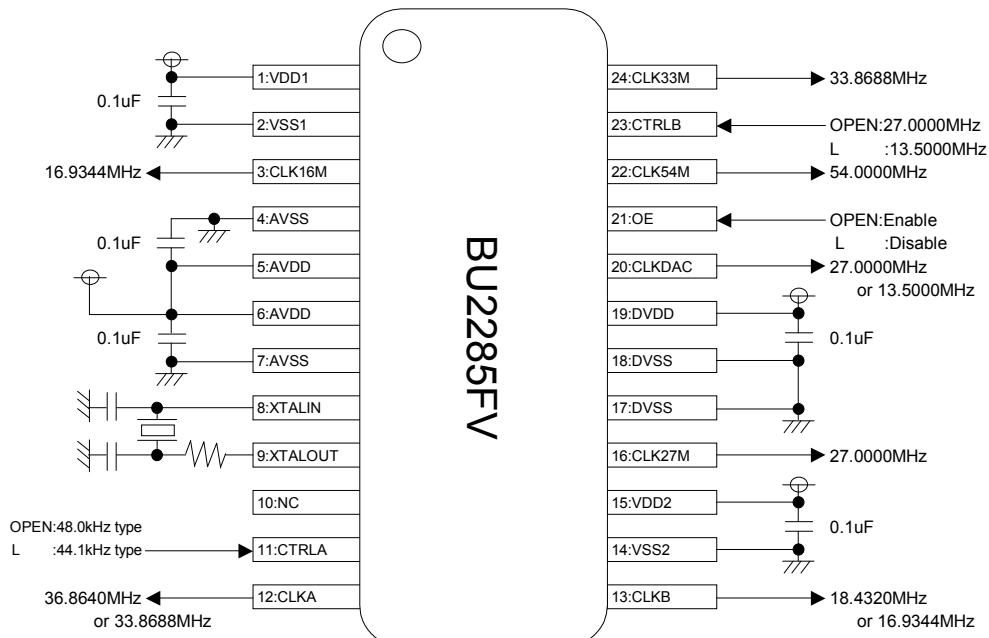


Fig.85

Pin function

PIN No.	PIN name	PIN function
1	VDD1	33MHz system power supply
2	VSS1	33MHz system GND
3	CLK16M	16.9344MHz output
4	AVSS	Analog GND
5	AVDD	Analog power supply
6	AVDD	Analog power supply
7	AVSS	Analog GND
8	XTALIN	Crystal input terminal
9	XTALOUT	Crystal output terminal
10	NC	NC
11	CTRLA	CLKA or B output selection (with pull-up)
12	CLKA	CTRLA=OPEN:36.8640MHz, CTRLA=L:33.8688MHz
13	CLKB	CTRLA=OPEN:18.4320MHz, CTRLA=L:16.9344MHz
14	VSS2	CLKA, B GND
15	VDD2	CLKA, B power supply
16	CLK27M	27.0000MHz output
17	DVSS	Digital GND
18	DVSS	Digital GND
19	DVDD	Digital power supply
20	CLKDAC	CTRLB=OPEN:27.0000MHz, CTRLB=L:13.5000MHz
21	OE	Output enable (with pull-up), OPEN:enable, L:disable
22	CLK54M	54.0000MHz output
23	CTRLB	CLKDAC output selection (with pull-up)
24	CLK33M	33.8688MHz output

Note) Basically, mount ICs to the printed circuit board for use. (If the ICs are not mounted to the printed circuit board, the characteristics of ICs may not be fully demonstrated.)

Mount 0.1μF capacitors in the vicinity of the IC PINs between 1PIN (VDD1) and 2PIN (VSS1), 4PIN (AVSS) and 5PIN (AVDD), 6PIN (AVDD) and 7PIN (AVSS), 14PIN (VSS2) and 15PIN (VDD2), and 17PIN/18PIN (DVSS) and 19PIN (DVDD), respectively.

Depending on the conditions of the printed circuit board, mount an additional electrolytic capacitor between the power supply and GND terminal. For EMI protection, it is effective to put ferrite beads in the origin of power supply to be fed to BU2285FV from the printed circuit board or to insert a capacitor (of 1Ω or less), which bypasses high frequency desired, between the power supply and the GND terminal.

● Example of application circuit

◎BU2363FV

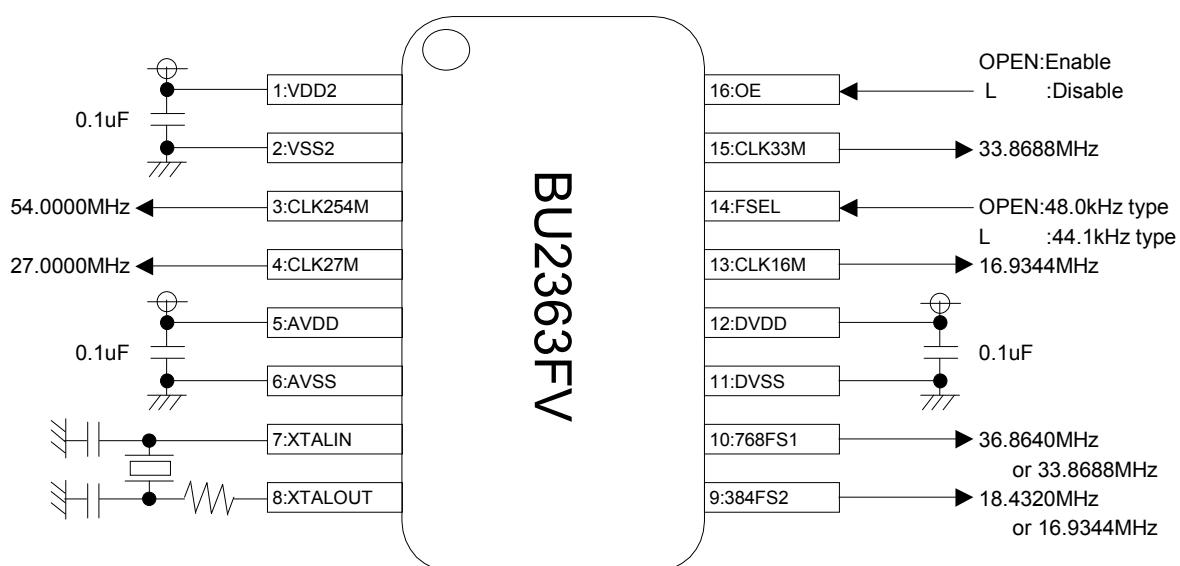


Fig.86

Pin function

PIN No.	PIN name	PIN function
1	VDD2	27MHz, 54MHz power supply
2	VSS2	27MHz, 54MHzGND
3	CLK54M	54.0000MHz output
4	CLK27M	27.0000MHz output
5	AVDD	Analog power supply
6	AVSS	Analog GND
7	XTALIN	Crystal input terminal
8	XTALOUT	Crystal output terminal
9	384FS2	FSEL=OPEN:18.4320MHz, FSEL=L:16.9344MHz
10	768FS1	FSEL=OPEN:36.8640MHz, FSEL=L:33.8688MHz
11	DVSS	Digital GND
12	DVDD	Digital power supply
13	CLK16M	16.9344MHz output
14	FSEL	9, 10PIN output selection(with pull-up) OPEN:18.4320MHz(9PIN), 36.8640MHz(10PIN) L:16.9344MHz(9PIN), 33.8688MHz(10PIN)
15	CLK33M	33.8688MHz output
16	OE	Output enable (with pull-up), OPEN:enable, L:disable

Note) Basically, mount ICs to the printed circuit board for use. (If the ICs are not mounted to the printed circuit board, the characteristics of ICs may not be fully demonstrated.)

Mount 0.1μF capacitors in the vicinity of the IC PINs between 1PIN (VDD2) and 2PIN (VSS2), 5PIN (AVDD) and 6PIN (AVSS), 11PIN (DVSS) and 12PIN (DVDD), respectively.

Depending on the conditions of the printed circuit board, mount an additional electrolytic capacitor between the power supply and GND terminal.

For EMI protection, it is effective to put ferrite beads in the origin of power supply to be fed to BU2363FV from the printed circuit board or to insert a capacitor (of 1Ω or less), which bypasses high frequency desired, between the power supply and the GND terminal.

Even though we believe that the example of recommended circuit is worth of a recommendation, please be sure to thoroughly recheck the characteristics before use.

●Cautions on use

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as applied voltage (VDD or VIN), operating temperature range (Topr), etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Recommended operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

(3) Reverse connection of power supply connector

The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

(4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines.

In this regard, for the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner.

Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(5) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

(7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

(9) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(10) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

(11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

● Product Designation

B U

2 2 8 5

F V

E 2

Part No.

Type

Package Type

Package and forming specification

BU2285FV

FV : SSOP-B24(BU2285FV)

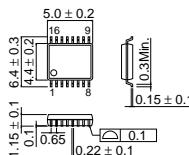
E2: Reel-like emboss taping

BU2363FV

FV : SSOP-B16(BU2363FV)

SSOP-B16

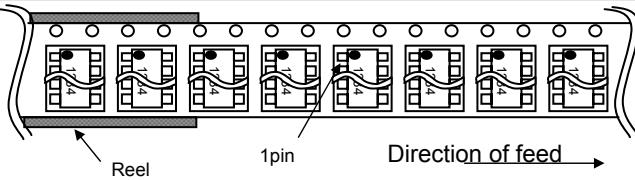
<Dimension>



(Unit:mm)

<Tape and Reel information>

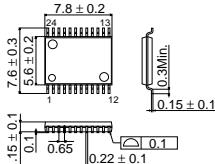
Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)



※When you order, please order in times the amount of package quantity.

SSOP-B24

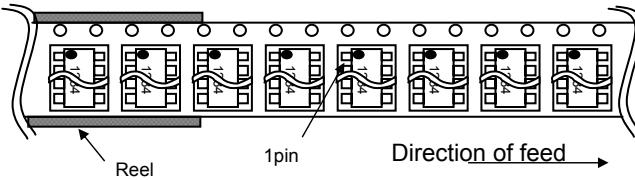
<Dimension>



(Unit:mm)

<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2000pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)



※When you order, please order in times the amount of package quantity.

- The contents described herein are correct as of September, 2008
- The contents described herein are subject to change without notice. For updates of the latest information, please contact and confirm with ROHM CO.,LTD.
- Any part of this application note must not be duplicated or copied without our permission.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams and information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by ROHM CO., LTD. is granted to any such buyer.
- The products described herein utilize silicon as the main material.
- The products described herein are not designed to be X ray proof.

The products listed in this catalog are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys). Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

Contact us for further information about the products.

San Diego	TEL: +1-858-625-3630	FAX: +1-858-625-3670	Tianjin	TEL: +86-22-23029181	FAX: +86-22-23029183
Atlanta	TEL: +1-770-754-5972	FAX: +1-770-754-0691	Shanghai	TEL: +86-21-6279-2727	FAX: +86-21-6247-2066
Boston	TEL: +1-978-371-0382	FAX: +1-928-438-7164	Hangzhou	TEL: +86-571-87658072	FAX: +86-571-87658071
Chicago	TEL: +1-847-368-1006	FAX: +1-847-368-1008	Nanjing	TEL: +86-25-8689-0018	FAX: +86-25-8689-0393
Dallas	TEL: +1-469-287-5366	FAX: +1-469-368-7973	Ningbo	TEL: +86-574-87654201	FAX: +86-574-87654208
Denver	TEL: +1-303-708-0908	FAX: +1-303-708-0858	Qingdao	TEL: +86-532-5779-312	FAX: +86-532-5779-653
Detroit	TEL: +1-248-348-9920	FAX: +1-248-348-9942	Suzhou	TEL: +86-512-6807-1300	FAX: +86-512-6807-2300
Nashville	TEL: +1-615-620-6700	FAX: +1-615-620-6702	Wuxi	TEL: +86-510-82702693	FAX: +86-510-82702992
Mexico	TEL: +52-33-3123-2001	FAX: +52-33-3123-2002	Shenzhen	TEL: +86-755-8307-3008	FAX: +86-755-8307-3003
Duesseldorf	TEL: +49-2154-921400	FAX: +49-2154-921400	Dongguan	TEL: +86-769-8393-3320	FAX: +86-769-8398-4140
Munich	TEL: +49-8999-216160	FAX: +49-8999-216176	Fuzhou	TEL: +86-591-8801-8698	FAX: +86-591-8801-8690
Stuttgart	TEL: +49-711-7272-370	FAX: +49-711-7272-3720	Guangzhou	TEL: +86-20-3878-8100	FAX: +86-20-3825-5965
France	TEL: +33-1-5697-3060	FAX: +33-1-5697-3080	Huizhou	TEL: +86-752-205-1054	FAX: +86-752-205-1059
United Kingdom	TEL: +44-1-908-306700	FAX: +44-1-908-235788	Xiamen	TEL: +86-592-238-5705	FAX: +86-592-239-8380
Denmark	TEL: +45-3694-4739	FAX: +45-3694-4789	Zhuhai	TEL: +86-756-3232-480	FAX: +86-756-3232-460
Espoo	TEL: +358-9725-54491	FAX: +358-9-7255-4499	Hong Kong	TEL: +852-2-740-6262	FAX: +852-2-975-6971
Salo	TEL: +358-2-8182-2334	FAX: +358-2-8182-2337	Taipei	TEL: +86-2-2500-6956	FAX: +86-2-2503-2869
Oulu	TEL: +358-8-5372930	FAX: +358-8-5372931	Kaohsiung	TEL: +86-7-237-0881	FAX: +86-7-238-7332
Barcelona	TEL: +34-9375-24320	FAX: +34-9375-24410	Singapore	TEL: +65-6332-2322	FAX: +65-6332-5662
Hungary	TEL: +36-1-4719338	FAX: +36-1-4719339	Philippines	TEL: +63-2-807-6872	FAX: +63-2-809-1422
Poland	TEL: +48-22-5757213	FAX: +48-22-5757001	Thailand	TEL: +66-2-254-4890	FAX: +66-2-256-6334
Russia	TEL: +7-495-739-41-74	FAX: +7-495-739-41-74	Kuala Lumpur	TEL: +60-3-7958-8355	FAX: +60-3-7958-8377
Seoul	TEL: +82-2-8182-700	FAX: +82-2-8182-715	Penang	TEL: +60-4-2286453	FAX: +60-4-2286452
Masan	TEL: +82-55-240-6236	FAX: +82-55-240-6236	Kyoto	TEL: +81-75-365-1218	FAX: +81-75-365-1228
Dalian	TEL: +86-411-8230-8549	FAX: +86-411-8230-8537	Yokohama	TEL: +81-45-476-2290	FAX: +81-45-476-2295
Beijing	TEL: +86-10-8525-2483	FAX: +86-10-8525-2489			

Excellence in Electronics

ROHM

ROHM CO., LTD.

21 Saini Mizonaki-cho, Ukyo-ku, Kyoto
615-8585, Japan
TEL: +81-75-311-2121 FAX: +81-75-315-0172
URL: <http://www.rohm.com>

Published by
KTC LSI Development Headquarters
LSI Business Promotion Group

Appendix

Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM CO.,LTD.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.

Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact your nearest sales office.

ROHM Customer Support System

[THE AMERICAS / EUROPE / ASIA / JAPAN](#)

www.rohm.com

Contact us : webmaster@rohm.co.jp